



MICROCHIP

MCP6291/1R/2/3/4/5

1.0 mA, 10 MHz Rail-to-Rail Op Amp

Features

- Gain Bandwidth Product: 10 MHz (typical)
- Supply Current: $I_Q = 1.0$ mA
- Supply Voltage: 2.4V to 6.0V
- Rail-to-Rail Input/Output
- Extended Temperature Range: -40°C to +125°C
- Available in Single, Dual and Quad Packages
- Single with CS (**MCP6293**)
- Dual with CS (**MCP6295**)

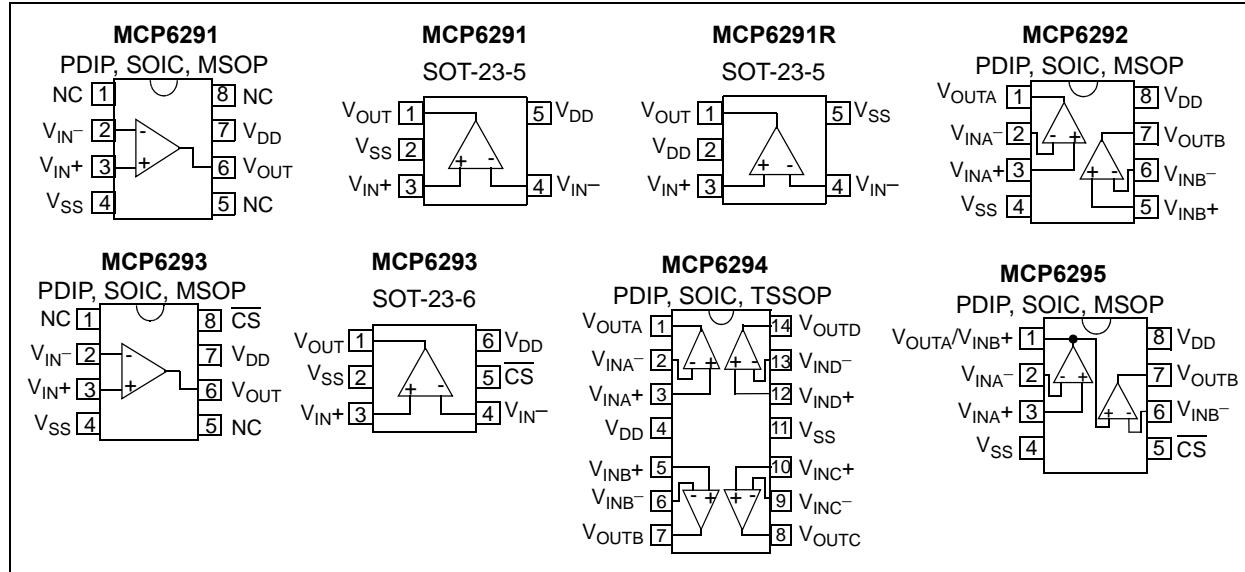
Applications

- Automotive
- Portable Equipment
- Photodiode Amplifier
- Analog Filters
- Notebooks and PDAs
- Battery-Powered Systems

Design Aids

- SPICE Macro Models
- FilterLab® Software
- Mindi™ Simulation Tool
- MAPS (Microchip Advanced Part Selector)
- Analog Demonstration and Evaluation Boards
- Application Notes

Package Types



MCP6291/1R/2/3/4/5

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

| | |
|---|--------------------------------------|
| $V_{DD} - V_{SS}$ | 7.0V |
| Current at Input Pins | ± 2 mA |
| Analog Inputs (V_{IN+}, V_{IN-}) ‡‡ | $V_{SS} - 1.0$ V to $V_{DD} + 1.0$ V |
| All Other Inputs and Outputs | $V_{SS} - 0.3$ V to $V_{DD} + 0.3$ V |
| Difference Input Voltage | $ V_{DD} - V_{SS} $ |
| Output Short Circuit Current | Continuous |
| Current at Output and Supply Pins | ± 30 mA |
| Storage Temperature..... | -65°C to +150°C |
| Maximum Junction Temperature (T_J) | +150°C |
| ESD Protection On All Pins (HBM; MM) | ≥ 4 kV; 400V |

† **Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡‡ See Section 4.1.2 "Input Voltage and Current Limits".

DC ELECTRICAL SPECIFICATIONS

| Electrical Characteristics: Unless otherwise indicated, $T_A = +25^\circ\text{C}$, $V_{DD} = +2.4\text{V}$ to $+5.5\text{V}$, $V_{SS} = \text{GND}$, $V_{OUT} \approx V_{DD}/2$, $V_{CM} = V_{DD}/2$, $V_L = V_{DD}/2$, $R_L = 10\text{k}\Omega$ to V_L and CS is tied low (refer to Figure 1-2 and Figure 1-3). | | | | | | |
|--|----------------------------|----------------|--------------|----------------|------------------------------|--|
| Parameters | Sym | Min | Typ | Max | Units | Conditions |
| Input Offset | | | | | | |
| Input Offset Voltage | V_{OS} | -3.0 | — | +3.0 | mV | $V_{CM} = V_{SS}$ (Note 1) |
| Input Offset Voltage (Extended Temperature) | V_{OS} | -5.0 | — | +5.0 | mV | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CM} = V_{SS}$ (Note 1) |
| Input Offset Temperature Drift | $\Delta V_{OS}/\Delta T_A$ | — | ± 1.7 | — | $\mu\text{V}/^\circ\text{C}$ | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CM} = V_{SS}$ (Note 1) |
| Power Supply Rejection Ratio | PSRR | 70 | 90 | — | dB | $V_{CM} = V_{SS}$ (Note 1) |
| Input Bias, Input Offset Current and Impedance | | | | | | |
| Input Bias Current | I_B | — | ± 1.0 | — | pA | Note 2 |
| At Temperature | I_B | — | 50 | 200 | pA | $T_A = +85^\circ\text{C}$ (Note 2) |
| At Temperature | I_B | — | 2 | 5 | nA | $T_A = +125^\circ\text{C}$ (Note 2) |
| Input Offset Current | I_{OS} | — | ± 1.0 | — | pA | Note 3 |
| Common Mode Input Impedance | Z_{CM} | — | $10^{13} 6$ | — | ΩpF | Note 3 |
| Differential Input Impedance | Z_{DIFF} | — | $10^{13} 3$ | — | ΩpF | Note 3 |
| Common Mode (Note 4) | | | | | | |
| Common Mode Input Range | V_{CMR} | $V_{SS} - 0.3$ | — | $V_{DD} + 0.3$ | V | |
| Common Mode Rejection Ratio | CMRR | 70 | 85 | — | dB | $V_{CM} = -0.3\text{V}$ to 2.5V , $V_{DD} = 5\text{V}$ |
| Common Mode Rejection Ratio | CMRR | 65 | 80 | — | dB | $V_{CM} = -0.3\text{V}$ to 5.3V , $V_{DD} = 5\text{V}$ |
| Open-Loop Gain | | | | | | |
| DC Open-Loop Gain (Large Signal) | A_{OL} | 90 | 110 | — | dB | $V_{OUT} = 0.2\text{V}$ to $V_{DD} - 0.2\text{V}$, $V_{CM} = V_{SS}$ (Note 1) |
| Output | | | | | | |
| Maximum Output Voltage Swing | V_{OL}, V_{OH} | $V_{SS} + 15$ | — | $V_{DD} - 15$ | mV | 0.5V Input Overdrive |
| Output Short Circuit Current | I_{SC} | — | ± 25 | — | mA | |
| Power Supply | | | | | | |
| Supply Voltage | V_{DD} | 2.4 | — | 6.0 | V | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ (Note 5) |
| Quiescent Current per Amplifier | I_Q | 0.7 | 1.0 | 1.3 | mA | $I_O = 0$ |

Note 1: The MCP6295's V_{CM} for op amp B (pins V_{OUTA}/V_{INB+} and V_{INB-}) is $V_{SS} + 100$ mV.

2: The current at the MCP6295's V_{INB-} pin is specified by I_B only.

3: This specification does not apply to the MCP6295's V_{OUTA}/V_{INB+} pin.

4: The MCP6295's V_{INB-} pin (op amp B) has a common mode range (V_{CMR}) of $V_{SS} + 100$ mV to $V_{DD} - 100$ mV.

The MCP6295's V_{OUTA}/V_{INB+} pin (op amp B) has a voltage range specified by V_{OH} and V_{OL} .

5: All parts with date codes November 2007 and later have been screened to ensure operation at $V_{DD} = 6.0\text{V}$. However, the other minimum and maximum specifications are measured at 2.4V and or 5.5V .

AC ELECTRICAL SPECIFICATIONS

Electrical Characteristics: Unless otherwise indicated, $T_A = +25^\circ\text{C}$, $V_{DD} = +2.4\text{V}$ to $+5.5\text{V}$, $V_{SS} = \text{GND}$, $V_{CM} = V_{DD}/2$, $V_{OUT} \approx V_{DD}/2$, $V_L = V_{DD}/2$, $R_L = 10 \text{k}\Omega$ to V_L , $C_L = 60 \text{pF}$, and $\overline{\text{CS}}$ is tied low (refer to Figure 1-2 and Figure 1-3).

| Parameters | Sym | Min | Typ | Max | Units | Conditions |
|-----------------------------|----------|-----|------|-----|------------------------------|--|
| AC Response | | | | | | |
| Gain Bandwidth Product | GBWP | — | 10.0 | — | MHz | |
| Phase Margin at Unity-Gain | PM | — | 65 | — | ° | $G = +1 \text{V/V}$ |
| Slew Rate | SR | — | 7 | — | $\text{V}/\mu\text{s}$ | |
| Noise | | | | | | |
| Input Noise Voltage | E_{ni} | — | 4.2 | — | μV_{P-P} | $f = 0.1 \text{ Hz to } 10 \text{ Hz}$ |
| Input Noise Voltage Density | e_{ni} | — | 8.7 | — | $\text{nV}/\sqrt{\text{Hz}}$ | $f = 10 \text{ kHz}$ |
| Input Noise Current Density | i_{ni} | — | 3 | — | $\text{fA}/\sqrt{\text{Hz}}$ | $f = 1 \text{ kHz}$ |

MCP6293/MCP6295 CHIP SELECT (CS) SPECIFICATIONS

Electrical Characteristics: Unless otherwise indicated, $T_A = +25^\circ\text{C}$, $V_{DD} = +2.4\text{V}$ to $+5.5\text{V}$, $V_{SS} = \text{GND}$, $V_{CM} = V_{DD}/2$, $V_{OUT} \approx V_{DD}/2$, $V_L = V_{DD}/2$, $R_L = 10 \text{k}\Omega$ to V_L , $C_L = 60 \text{pF}$, and $\overline{\text{CS}}$ is tied low (refer to Figure 1-2 and Figure 1-3).

| Parameters | Sym | Min | Typ | Max | Units | Conditions |
|--|------------|--------------|------|--------------|---------------|--|
| CS Low Specifications | | | | | | |
| CS Logic Threshold, Low | V_{IL} | V_{SS} | — | $0.2 V_{DD}$ | V | |
| CS Input Current, Low | I_{CSL} | — | 0.01 | — | μA | $\overline{\text{CS}} = V_{SS}$ |
| CS High Specifications | | | | | | |
| CS Logic Threshold, High | V_{IH} | $0.8 V_{DD}$ | — | V_{DD} | V | |
| CS Input Current, High | I_{CSH} | — | 0.7 | 2 | μA | $\overline{\text{CS}} = V_{DD}$ |
| GND Current per Amplifier | I_{SS} | — | -0.7 | — | μA | $\overline{\text{CS}} = V_{DD}$ |
| Amplifier Output Leakage | — | — | 0.01 | — | μA | $\overline{\text{CS}} = V_{DD}$ |
| Dynamic Specifications (Note 1) | | | | | | |
| CS Low to Valid Amplifier Output, Turn-on Time | t_{ON} | — | 4 | 10 | μs | $\overline{\text{CS}} \text{ Low} \leq 0.2 V_{DD}$, $G = +1 \text{V/V}$, $V_{IN} = V_{DD}/2$, $V_{OUT} = 0.9 V_{DD}/2$, $V_{DD} = 5.0\text{V}$ |
| $\overline{\text{CS}}$ High to Amplifier Output High-Z | t_{OFF} | — | 0.01 | — | μs | $\overline{\text{CS}} \text{ High} \geq 0.8 V_{DD}$, $G = +1 \text{V/V}$, $V_{IN} = V_{DD}/2$, $V_{OUT} = 0.1 V_{DD}/2$ |
| Hysteresis | V_{HYST} | — | 0.6 | — | V | $V_{DD} = 5\text{V}$ |

Note 1: The input condition (V_{IN}) specified applies to both op amp A and B of the MCP6295. The dynamic specification is tested at the output of op amp B (V_{OUTB}).

MCP6291/1R/2/3/4/5

TEMPERATURE SPECIFICATIONS

| Electrical Characteristics: Unless otherwise indicated, $V_{DD} = +2.4V$ to $+5.5V$ and $V_{SS} = GND$. | | | | | | |
|--|---------------|-----|-----|------|-------|------------|
| Parameters | Sym | Min | Typ | Max | Units | Conditions |
| Temperature Ranges | | | | | | |
| Operating Temperature Range | T_A | -40 | — | +125 | °C | Note |
| Storage Temperature Range | T_A | -65 | — | +150 | °C | |
| Thermal Package Resistances | | | | | | |
| Thermal Resistance, 5L-SOT-23 | θ_{JA} | — | 256 | — | °C/W | |
| Thermal Resistance, 6L-SOT-23 | θ_{JA} | — | 230 | — | °C/W | |
| Thermal Resistance, 8L-PDIP | θ_{JA} | — | 85 | — | °C/W | |
| Thermal Resistance, 8L-SOIC | θ_{JA} | — | 163 | — | °C/W | |
| Thermal Resistance, 8L-MSOP | θ_{JA} | — | 206 | — | °C/W | |
| Thermal Resistance, 14L-PDIP | θ_{JA} | — | 70 | — | °C/W | |
| Thermal Resistance, 14L-SOIC | θ_{JA} | — | 120 | — | °C/W | |
| Thermal Resistance, 14L-TSSOP | θ_{JA} | — | 100 | — | °C/W | |

Note: The Junction Temperature (T_J) must not exceed the Absolute Maximum specification of $+150^{\circ}\text{C}$.

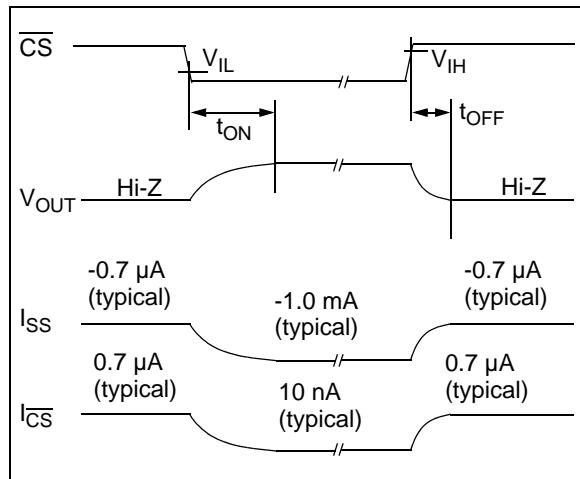


FIGURE 1-1: Timing Diagram for the Chip Select (CS) pin on the MCP6293 and MCP6295.

1.1 Test Circuits

The test circuits used for the DC and AC tests are shown in [Figure 1-2](#) and [Figure 1-3](#). The bypass capacitors are laid out according to the rules discussed in [Section 4.6 “Supply Bypass”](#).

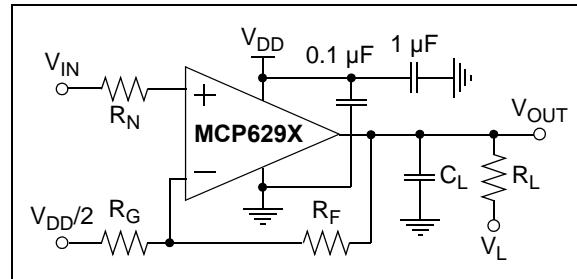


FIGURE 1-2: AC and DC Test Circuit for Most Non-Inverting Gain Conditions.

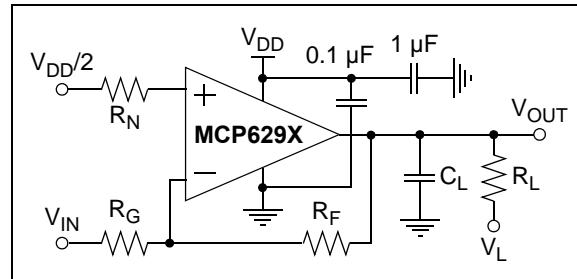
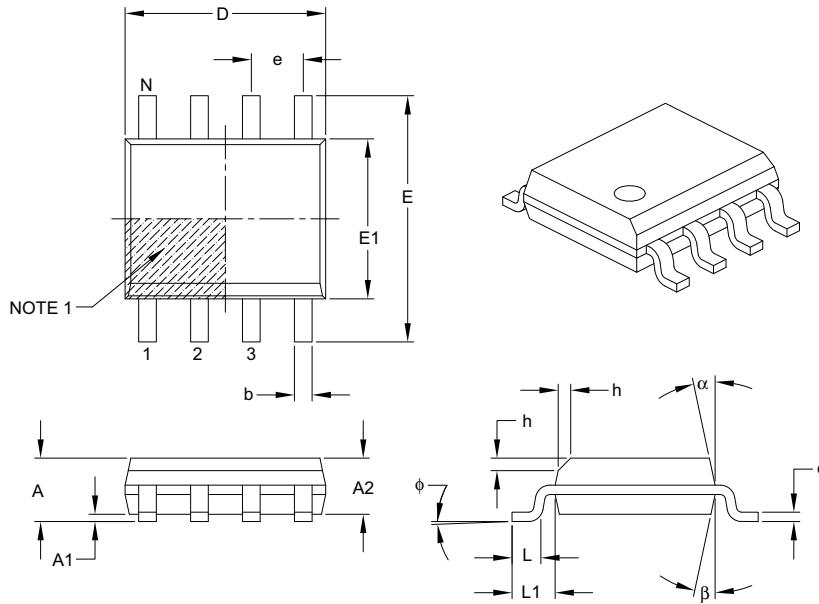


FIGURE 1-3: AC and DC Test Circuit for Most Inverting Gain Conditions.

8-Lead Plastic Small Outline (SN) – Narrow, 3.90 mm Body [SOIC]



| Units | | MILLIMETERS | | |
|--------------------------|----|-------------|----------|------|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 8 | |
| Pitch | e | | 1.27 BSC | |
| Overall Height | A | — | — | 1.75 |
| Molded Package Thickness | A2 | 1.25 | — | — |
| Standoff § | A1 | 0.10 | — | 0.25 |
| Overall Width | E | | 6.00 BSC | |
| Molded Package Width | E1 | | 3.90 BSC | |
| Overall Length | D | | 4.90 BSC | |
| Chamfer (optional) | h | 0.25 | — | 0.50 |
| Foot Length | L | 0.40 | — | 1.27 |
| Footprint | L1 | | 1.04 REF | |
| Foot Angle | ϕ | 0° | — | 8° |
| Lead Thickness | c | 0.17 | — | 0.25 |
| Lead Width | b | 0.31 | — | 0.51 |
| Mold Draft Angle Top | α | 5° | — | 15° |
| Mold Draft Angle Bottom | β | 5° | — | 15° |

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-057B

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| PART NO. | - | X | /XX | |
|--------------------|-------------------|---|---------|--|
| Device | Temperature Range | | Package | |
| Device: | | | | |
| | MCP6291: | Single Op Amp | | |
| | MCP6291T: | Single Op Amp (Tape and Reel) (SOIC, MSOP, SOT-23-5) | | |
| | MCP6291RT: | Single Op Amp (Tape and Reel) (SOT-23-5) | | |
| | MCP6292: | Dual Op Amp | | |
| | MCP6292T: | Dual Op Amp (Tape and Reel) (SOIC, MSOP) | | |
| | MCP6293: | Single Op Amp with Chip Select | | |
| | MCP6293T: | Single Op Amp with Chip Select (Tape and Reel) (SOIC, MSOP, SOT-23-6) | | |
| | MCP6294: | Quad Op Amp | | |
| | MCP6294T: | Quad Op Amp (Tape and Reel) (SOIC, TSSOP) | | |
| | MCP6295: | Dual Op Amp with Chip Select | | |
| | MCP6295T: | Dual Op Amp with Chip Select (Tape and Reel) (SOIC, MSOP) | | |
| Temperature Range: | E | = -40° C to +125° C | | |
| Package: | OT | = Plastic Small Outline Transistor (SOT-23), 5-lead (MCP6291, MCP6291R) | | |
| | CH | = Plastic Small Outline Transistor (SOT-23), 6-lead (MCP6293) | | |
| | MS | = Plastic MSOP, 8-lead | | |
| | P | = Plastic DIP (300 mil body), 8-lead, 14-lead | | |
| | SN | = Plastic SOIC, (3.90 mm body), 8-lead | | |
| | SL | = Plastic SOIC (3.90 mm body), 14-lead | | |
| | ST | = Plastic TSSOP (4.4 mm body), 14-lead | | |
| Examples: | | | | |
| a) | MCP6291-E/SN: | Extended Temperature, 8 lead SOIC package. | | |
| b) | MCP6291-E/MS: | Extended Temperature, 8 lead MSOP package. | | |
| c) | MCP6291-E/P: | Extended Temperature, 8 lead PDIP package. | | |
| d) | MCP6291T-E/OT: | Tape and Reel, Extended Temperature, 5 lead SOT-23 package. | | |
| e) | MCP6291RT-E/OT: | Tape and Reel, Extended Temperature, 5 lead SOT-23 package. | | |
| a) | MCP6292-E/SN: | Extended Temperature, 8 lead SOIC package. | | |
| b) | MCP6292-E/MS: | Extended Temperature, 8 lead MSOP package. | | |
| c) | MCP6292-E/P: | Extended Temperature, 8 lead PDIP package. | | |
| d) | MCP6292T-E/SN: | Tape and Reel, Extended Temperature, 8 lead SOIC package. | | |
| a) | MCP6293-E/SN: | Extended Temperature, 8 lead SOIC package. | | |
| b) | MCP6293-E/MS: | Extended Temperature, 8 lead MSOP package. | | |
| c) | MCP6293-E/P: | Extended Temperature, 8 lead PDIP package. | | |
| d) | MCP6293T-E/CH: | Tape and Reel, Extended Temperature, 6 lead SOT-23 package. | | |
| a) | MCP6294-E/P: | Extended Temperature, 14 lead PDIP package. | | |
| b) | MCP6294T-E/SL: | Tape and Reel, Extended Temperature, 14 lead SOIC package. | | |
| c) | MCP6294-E/SL: | Extended Temperature, 14 lead SOIC package. | | |
| d) | MCP6294-E/ST: | Extended Temperature, 14 lead TSSOP package. | | |
| a) | MCP6295-E/SN: | Extended Temperature, 8 lead SOIC package. | | |
| b) | MCP6295-E/MS: | Extended Temperature, 8 lead MSOP package. | | |
| c) | MCP6295-E/P: | Extended Temperature, 8 lead PDIP package. | | |
| d) | MCP6295T-E/SN: | Tape and Reel, Extended Temperature, 8 lead SOIC package. | | |